SPECIFICATION

Ceramic Antenna 3216 Size

2400-2500 MHz

P/N: HM3216ANT24HS-HML2

Manufacturer: 深圳市和鸣微科技有限公司
Shenzhen HamyWe Technology Co., Ltd

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1. Frequency

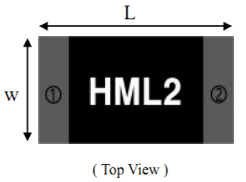
2400-2500 MHz

2. Applications

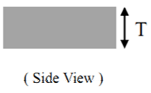
For Miniaturized Bluetooth System

3. Dimensions (Unit : mm)

1). Over View :

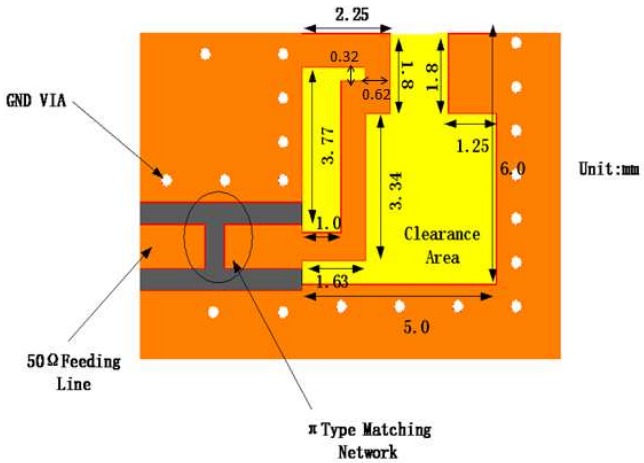


Number	Terminal Name
①	INPUT
②	NC

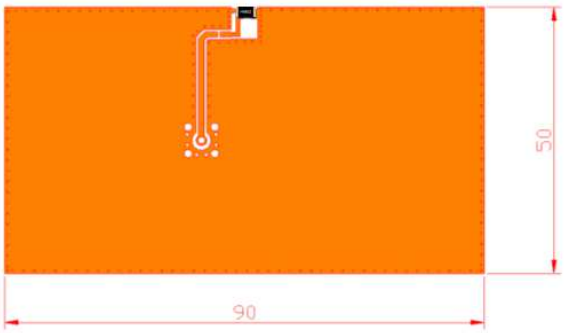


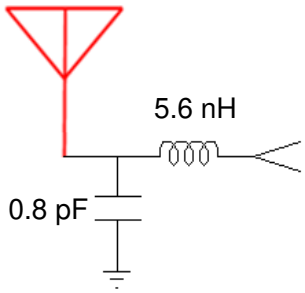
Symbols	L	W	T	A
Dimensions	3.2+/-0.2	1.6+/-0.2	0.5+/-0.1	0.4+/-0.1

2). PCB Layout (Unit : mm) :



4. Evaluation Board Size and Matching Circuits





5. Electrical Characteristics

Part Number	HM3216ANT24HS-HML2
Central Frequency	2450 MHz
Bandwidth	100(typ.) MHz
V.S.W.R	≤2.0
Peak Gain	4.11 dBi
Impedance	50 Ohm
Polarization	Linear
Azimuth Beamwidth	Omni-directional

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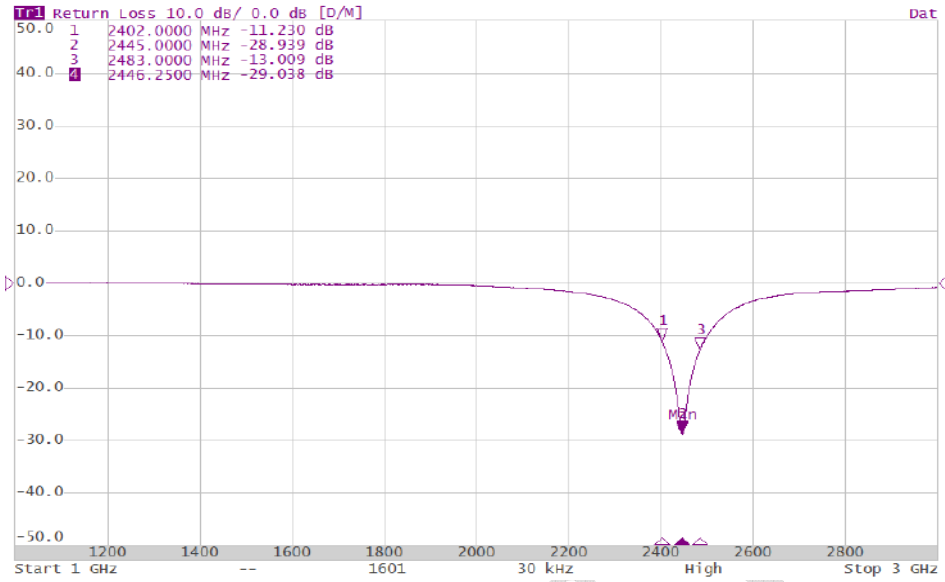
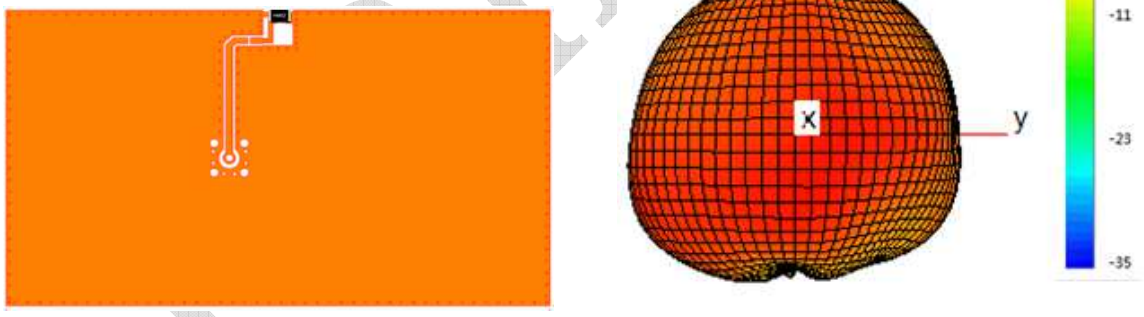
6. Return Loss (S11)

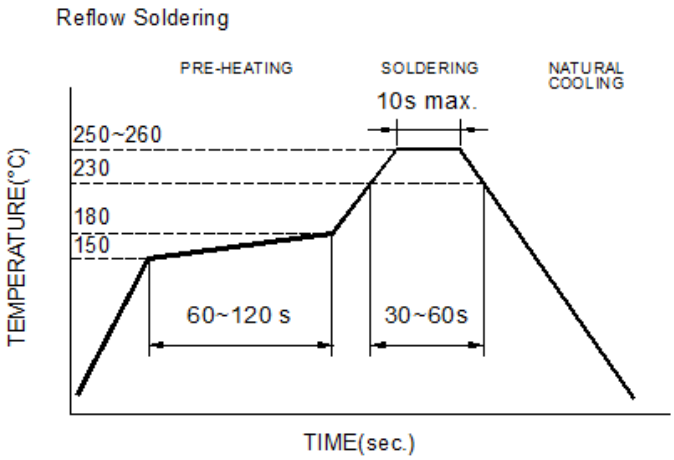


7. Radiation Pattern & Efficiency



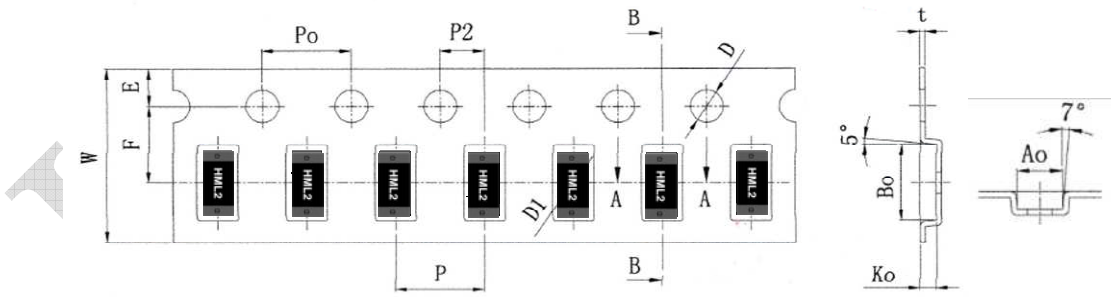
Frequency (MHz)	2400	2450	2500
Efficiency (dB)	-2.08	-1.94	-2.15
Efficiency (%)	62	64	61
Gain (dBi)	3.43	4.11	3.67

8. Reflow Soldering Standard Condition



9. Packaging and Dimensions

- Plastic Tape



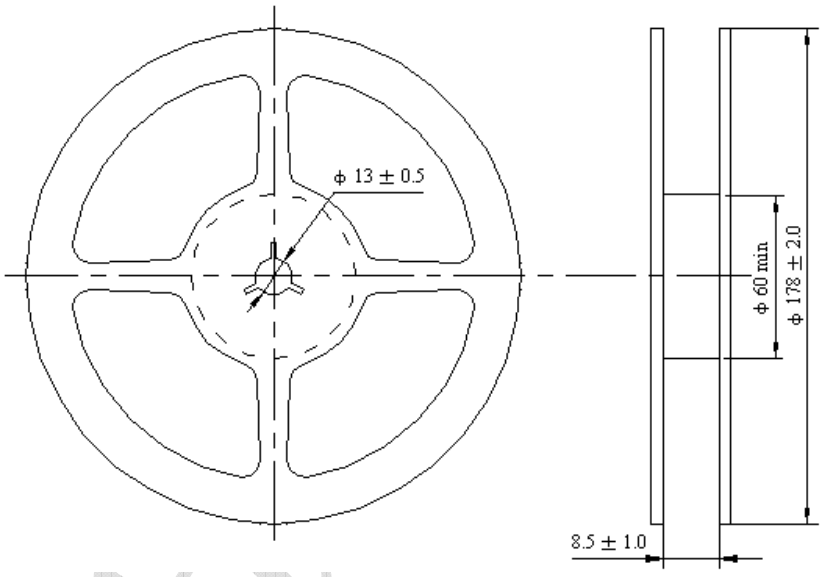
外觀	規格	公差
W	8.00	±0.10
P	4.00	±0.10
E	1.75	±0.10
F	3.50	±0.05
P2	2.00	±0.05
D	1.50	+0.10 −0.00
D1	1.00	±0.10
Po	4.00	±0.10
10Po	40.00	±0.20

外觀	規格	公差
Ao	1.85	±0.10
Bo	3.50	±0.10
Ko	0.73	±0.10
t	0.23	±0.05

- **Remarks for Package**

Reserve a length of 150~200mm for the trailer of the carrier and 250~300 mm for the leader of the carrier and further 250mm of cover tape at the leading part of the carrier.

- **Reel (5000 pcs/Reel)**



- **Storage Period**

Oxidizable Material, 12 months in vacuum sealed bag, please repack within 168 hours by re-seal the package treatment after using.

Storage Temperature Range : <30 degree C, Humidity : <60%RH

10. Dependability Test

Test item	Test condition / Test method	Specification
Solderability IEC 60068-2-58 GB/T2423.28	*Solder bath temperature：240±5℃ *Immersion time：2±0.5 sec Solder：Sn96.5Ag3.0Gu0.5 for lead-free.	At least 95% of a surface of each terminal electrode must be covered by fresh solder.
Leaching (Resistance to dissolution of metallization) JIS C5101	*Solder bath temperature：260±5℃ *Leaching immersion time：10±1 sec Solder : Sn96.5 Ag3.0 Gu0.5 for lead-free.	Loss of metallization on the edges of each electrode shall not exceed 25%.
Resistance to soldering heat IEC 60068-2-58 GB/T2423.28	*Preheating temperature：120~150℃, 1 minute. *Solder temperature：260±5℃ *Immersion time：10±1 sec Solder：Sn96.5Ag3.0Gu0.5 for lead-free Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature. Loss of metallization on the edges of each electrode shall not exceed 25%.
Drop Test IEC 60068-2-32 GB/T2423.8 Customer’ s specification.	*Height：50 cm *Test Surface: Rigid surface of concrete or steel. *Times：6 surfaces for each units；2 times for each side.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Vibration IEC 60068-2-6 GB/T 2423.10	*Frequency：10Hz~55Hz~10Hz(1min) *Total amplitude：1.5mm *Test times：6hrs.(Two hrs each in three mutually perpendicular directions)	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Adhesive Strength of Termination IEC60068-2-21 GB/T 2423.6	*Pressurizing force： 5N(≦0603)；10N(>0603) *Test time:10±1 sec	No remarkable damage or removal of the termination.

Bending test IEC 60068-2-21 GB/T 2423.29	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 2mm and then pressure shall be maintained for 10±1 sec. Measurement to be made after keeping at room temperature for 24±2 hours.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Temperature cycle IEC60068-2-14 GB/T 2423.22	30 minutes at-40℃±2℃. 10~15 minutes at room temperature. 30minutes at +85℃±2℃. 10~15 minutes at room temperature. Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
High temperature IEC 60068-2-2 GB/T2423.2	*Temperature：85±2℃. *Test duration：500+24/-0 hours. Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics.
Humidity (steady conditions) IEC60068-2-3 GB/T 2423.3	*Humidity：85±5%R.H. *Temperature：85±2℃. *Time：500+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs ※ 200hrs measuring the first data then 300hrs data.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Low temperature IEC 60068-2-1 GB/T2423.1	*Temperature：-40±2℃. *Test duration：500+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.

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